Performance Characteristics:

• Frequency band: 2.4~8GHz

Insertion loss: 3.4 dB

Attenuation range: 0.5 to 31.5dB

Input/output voltage standing wave ratio: 1.4/1.3

• Package size: 3mmx3mm

Product Description:

CW425SP3is a GaAs MMIC 6-bit CNC attenuator chip with a frequency coverage range of 2.4 to 8GHz and less than 4dB of insertion loss. The CW425SP3 uses +5V/0V logic control with a switching speed of less than 20ns.

Electrical parameters: (T_A=25°C, Vc=+5V/0V)

| Indicators | | Minimum | Typical value | Maximum value | Units |
|-------------------------------|-------|---------|---------------|---------------|-------|
| Frequency range | | | GHz | | |
| Insertion loss | | - | 3.4 | 4 | dB |
| Attenuation range | | - | 31.5 | - | dB |
| Attenuation accuracy | 0.5dB | 0.3 | 0.5 | 0.7 | dB |
| | 1dB | 0.7 | 1 | 1.2 | dB |
| | 2dB | 1.7 | 2 | 2.3 | dB |
| | 4dB | 3.7 | 4 | 4.3 | dB |
| | 8dB | 7.6 | 8 | 8.3 | dB |
| | 16dB | 15.4 | 16 | 16.3 | dB |
| Enter the standing wave ratio | | - | 1.4 | - | dB |
| Output standing wave ratio | | - | 1.3 | - | dB |

Use limiting parameters:

| Control voltage range | Vdd+0.5V | |
|-----------------------|-----------|--|
| Storage temperature | -65℃~150℃ | |
| Service temperature | -55℃~125℃ | |

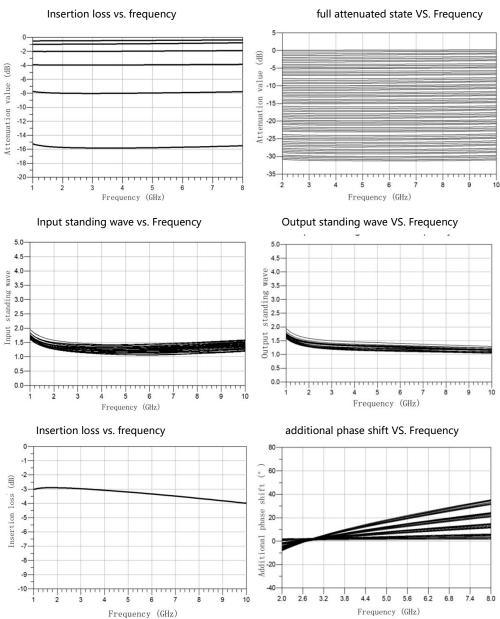
website: www.cdcwtec.com

portraiture: 028-8709823 185

TOP VIEW

Address: No. 5, Gaopeng East Road, Chengdu Hi-tech Zone

Typical curve:



website: www.cdcwtec.com

portraiture: 028-8709823

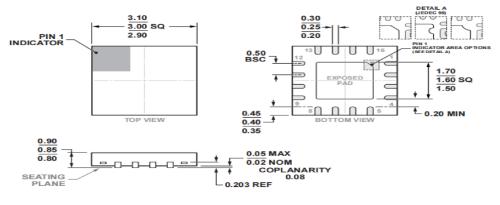
Truth table:

| 16dB | 8dB | 4dB | 2dB | 1dB | 0.5dB | 6 |
|------|------|------|------|------|-------|--------------------|
| V1 | V2 | V3 | V4 | V5 | V6 | Status |
| High | High | High | High | High | High | Reference state |
| High | High | High | High | High | Low | 0.5dB |
| High | High | High | High | Low | High | 1dB |
| High | High | High | Low | High | High | 2dB |
| High | High | Low | High | High | High | 4dB |
| High | Low | High | High | High | High | 8dB |
| Low | High | High | High | High | High | 16dB |
| Low | Low | Low | Low | Low | Low | 31.5dB |

Note: Low=0 \sim 0.2V; High=Vdd \pm 0.2V (Vdd=+3.3V \sim +5V)

Outline Drawing

■ ANALOG DEVICES



COMPLIANT TO JEDEC STANDARDS MO-220-VEED-4

Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|------------------|-------------|--|---------------------|
| 1, 3, 10, 12 | GND | Package bottom has an exposed metal paddle that must also be connected to RF ground. | GND |
| 2, 11 | RFIN, RFOUT | This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required. | |
| 4, 5, 6, 7, 8, 9 | V1 - V6 | See truth table and control voltage table. | 50000 = |
| 13, 14, 16 | NC | This pin should be connected to PCB RF ground to maximize performance. | |
| 15 | VDD | Supply Voltage | |

Instructions:

Storage: The chip must be placed in a container with electrostatic protection and stored in a nitrogen environment.

Cleaning treatment: The bare chip must be operated and used in a purified environment. It is forbidden to use liquid cleaning agent to clean the chip.

Electrostatic protection: Strictly comply with the ESD protection requirements to avoid electrostatic damage to the components.

General operation: Use vacuum chuck or precision pointed tweezers to pick up the chip. Avoid touching the surface of the chip with tools or fingers during handling.

Mounting operation: The chip can be installed using AuSn solder eutectic welding or conductive adhesive bonding process. The mounting surface must be clean and flat.

Bonding operation: Input and output with 2 (recommended diameter of 25um gold wire) bonding wire, bonding wire length less than 250um is optimal. It is recommended to use the smallest possible ultrasonic energy. Bonding begins at the pressure point on the chip and ends at the package (or substrate).

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